

AMENDMENTS TO THE CLAIMS

1. (Currently amended) An electronic component comprising an electronic component body having an external electrode thereon, the external electrode comprising a first sintered electrode layer and a second sintered electrode layer disposed thereon, the first and second sintered electrode layers comprising different metals, wherein

the first sintered electrode layer comprises a first borosilicate glass containing an alkali metal, the first borosilicate glass containing 85% to 95% by weight of silicon and 0.5% to 1.5% by weight of the alkali metal based on 100% by weight of all ~~contained~~ elements other than boron therein according to analysis with a wavelength dispersive X-ray microanalyzer; and

the second sintered electrode layer comprises a second borosilicate glass containing an alkali metal, the second borosilicate glass containing 65% to 80% by weight of silicon and 3.5% to 8.0% by weight of the alkali metal based on 100% by weight of all ~~contained~~ elements other than boron therein according to analysis with a wavelength dispersive X-ray microanalyzer.

2. (Previously presented) The electronic component according to Claim 1, wherein the alkali metal contained in the first borosilicate glass ~~is~~ comprises potassium; and the alkali metal contained in the second borosilicate glass comprises sodium.

3. (Previously presented) The electronic component according to Claim 1, wherein the metal in the second sintered electrode layer comprises a noble metal.

4 . (Previously presented) The electronic component according to Claim 3, wherein the noble metal comprises silver.

5. (Previously presented) The electronic component according to Claim 1, wherein the electronic component body includes internal electrodes comprising a metal; and the metal of the first sintered electrode layer is a metal that is alloyed with the internal electrodes.

6. (Previously presented) The electronic component according to Claim 5, wherein the internal electrodes comprise nickel; and the metal that is alloyed with the internal electrodes comprises copper.

7. (Previously presented) The electronic component according to Claim 1, wherein an external electrode of the electronic component is connected to an electrode on a mounting substrate with a conductive adhesive.

8 - 15. (Canceled)

16. (Previously presented) The electronic component according to Claim 4, wherein the metal in the second sintered electrode layer comprises silver-palladium.

17. (Previously presented) The electronic component according to Claim 4, wherein the alkali metal contained in the first borosilicate glass comprises potassium; and the alkali metal contained in the second borosilicate glass comprises sodium.

18. (Previously presented) The electronic component according to Claim 6, wherein the metal in the second sintered electrode layer comprises silver; the alkali metal

contained in the first borosilicate glass comprises potassium; and the alkali metal contained in the second borosilicate glass comprises sodium.

19. (Previously presented) The electronic component according to Claim 7, wherein the metal in the second sintered electrode layer comprises silver; the alkali metal contained in the first borosilicate glass comprises potassium; and the alkali metal contained in the second borosilicate glass comprises sodium.

20. (Canceled)